L Number	Hits	Search Text	DB	Time stamp
35	7	("4716299" | "5164974" | "5746565" | "5842824" | "5980187" | "6414744" | "6419439").PN.	USPAT	2003/12/31 09:53
-	31	(("1657416") or ("3831502") or ("3882765") or ("4215609") or ("4328727") or ("4476758") or ("4515052") or ("4559855") or ("4567653") or ("4781668") or ("4962684") or ("5797830") or ("6286404")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/30 11:35
-	71	(83/948).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/30 13:28
-	738	83/508.3,425.3,425.4.ccls. not saw	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/30 13:41
-	418	(83/500,503).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/31 09:36
-	2	("3387524" | "3651728").PN.	USPAT	2003/12/30 13:48
-	6	3828633.URPN.	USPAT	2003/12/30 13:48
-	19	("0180373" | "0461747" | "1751549" | "1822209" | "1978703" | "2456866" | "2476326" | "2597279" | "2941560" | "3120777" | "3656382" | "3742796" | "3769864" | "3788180" | "3828633" | "3982455" | "4046043" | "4370910" | "4846032").PN.	USPAT	2003/12/30 13:49
-	4	("1261368" | "2131851" | "3165951" | "3213733").PN.	USPAT	2003/12/30 13:50
-	10	4046043.URPN.	USPAT	2003/12/30 13:51
-	3	5152206.URPN.	USPAT	2003/12/30 13:52
-	0	831866.URPN.	USPAT	2003/12/30 14:03
-	247	electrostatic near dissipative	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/31 09:36
-	2	(electrostatic near dissipative) and 269.clas.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/31 09:37
-	48	(electrostatic near dissipative) and (vacuum or suction)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/31 09:41
-	0	((electrostatic near dissipative) and (vacuum or suction)) and (438.ccls. or 125.ccls. or 451.ccls. or 83.ccls. or 269.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/31 09:40
-	0	((electrostatic near dissipative) and (vacuum or suction)) and (438.clas. or 125.clas. or 451.clas. or 83.clas. or 269.clas.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/31 09:40

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| - | 12 | ((electrostatic near dissipative) and (vacuum or suction)) and (semiconductor or wafer) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/12/31 09:41 |
| - | 0 | 871262.URPN. | USPAT | 2003/12/31 09:43 |